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Kind regards,

Team Nexperia

# 74HC4020-Q100; 74HCT4020-Q100

14-stage binary ripple counter

Rev. 1 — 23 May 2013

Product data sheet

## 1. General description

The 74HC4020-Q100; 74HCT4020-Q100 are 14-stage binary ripple counters with a clock input ( $\overline{CP}$ ), an overriding asynchronous master reset input (MR) and 12 buffered parallel outputs (Q0, and Q3 to Q13). The counter advances on the HIGH-to-LOW transition of  $\overline{CP}$ . A HIGH on MR clears all counter stages and forces all outputs LOW, independent of the state of  $\overline{CP}$ . Each counter stage is a static toggle flip-flop.. Inputs include clamp diodes. This enables the use of current limiting resistors to interface inputs to voltages in excess of  $V_{CC}$ .

This product has been qualified to the Automotive Electronics Council (AEC) standard Q100 (Grade 1) and is suitable for use in automotive applications.

## 2. Features and benefits

- Automotive product qualification in accordance with AEC-Q100 (Grade 1)
  - ◆ Specified from -40 °C to +85 °C and from -40 °C to +125 °C
- Input levels:
  - ◆ For 74HC4020-Q100: CMOS level
  - ♦ For 74HCT4020-Q100: TTL level
- Complies with JEDEC standard no. 7A
- ESD protection:
  - ◆ MIL-STD-883, method 3015 exceeds 2000 V
  - HBM JESD22-A114F exceeds 2000 V
  - lacktriangle MM JESD22-A115-A exceeds 200 V (C = 200 pF, R = 0  $\Omega$ )
- Multiple package options

## 3. Applications

- Frequency dividing circuits
- Time delay circuits
- Control counters

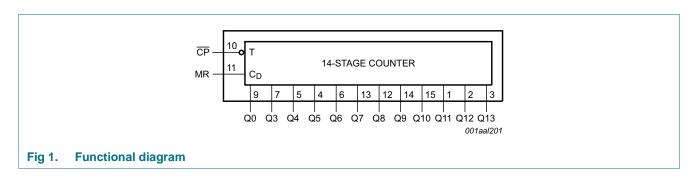


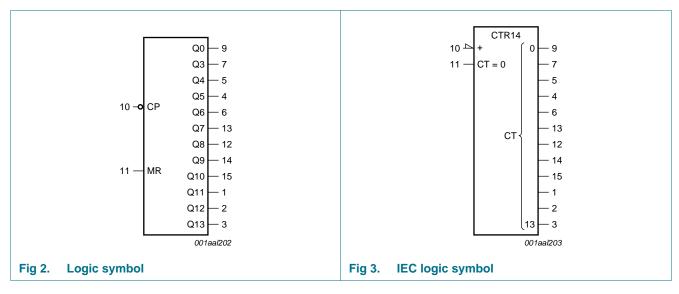
## 4. Ordering information

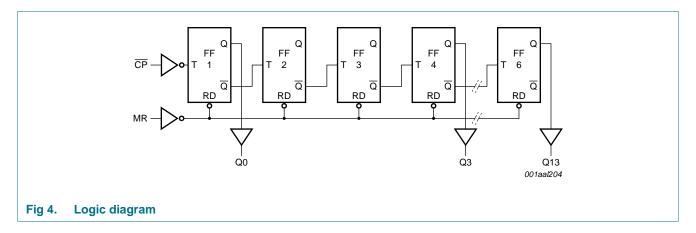
Table 1. Ordering information

Type number	Package						
	Temperature range	Name	Description	Version			
74HC4020D-Q100	–40 °C to +125 °C	SO16	plastic small outline package; 16 leads;	SOT109-1			
74HCT4020D-Q100			body width 3.9 mm				
74HC4020PW-Q100	–40 °C to +125 °C	TSSOP16	plastic thin shrink small outline package; 16	SOT403-1			
74HCT4020PW-Q100			leads; body width 4.4 mm				
74HC4020BQ-Q100	–40 °C to +125 °C	DHVQFN16	I amount a second and a second	SOT763-1			
74HCT4020BQ-Q100			enhanced very thin quad flat package; no leads; 16 terminals; body 2.5 $\times$ 3.5 $\times$ 0.85 mm				

## 5. Functional diagram

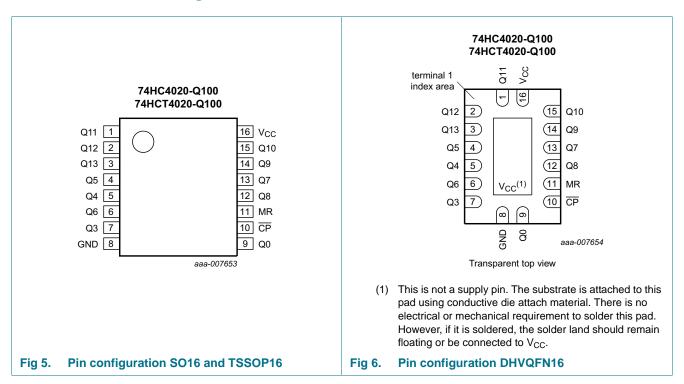






## 6. Pinning information

## 6.1 Pinning



### 6.2 Pin description

Table 2. Pin description

Symbol	Pin	Description
Q0, Q3 to Q13	9, 7, 5, 4, 6, 13, 12, 14, 15, 1, 2, 3	output
GND	8	ground (0 V)
CP	10	clock input (HIGH-to-LOW, edge-triggered)
MR	11	master reset input (active HIGH)
V <sub>CC</sub>	16	positive supply voltage

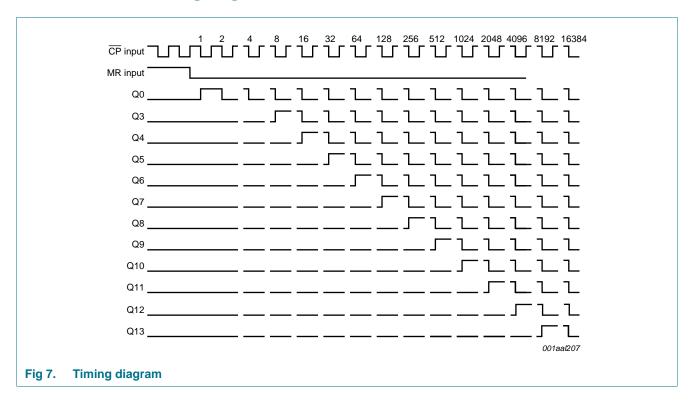
## 7. Functional description

Table 3. Function table

Input CP	Output	
СР	MR	Q0, Q3 to Q13
$\uparrow$	L	no change
$\downarrow$	L	count
X	Н	L

[1] H = HIGH voltage level; L = LOW voltage level; X = don't care; ↑ = LOW-to-HIGH clock transition; ↓ = HIGH-to-LOW clock transition.

## 7.1 Timing diagram



## 8. Limiting values

Table 4. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134). Voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions	Min	Max	Unit
$V_{CC}$	supply voltage		-0.5	+7	V
I <sub>IK</sub>	input clamping current	$V_I < -0.5 \text{ V or } V_I > V_{CC} + 0.5 \text{ V}$	-	±20	mA
I <sub>OK</sub>	output clamping current	$V_I < -0.5 \text{ V or } V_I > V_{CC} + 0.5 \text{ V}$	-	±20	mA
Io	output current	$-0.5 \text{ V} < \text{V}_{\text{O}} < \text{V}_{\text{CC}} + 0.5 \text{ V}$	-	±25	mA
I <sub>CC</sub>	supply current		-	±50	mA
$I_{GND}$	ground current		-	±50	mA
T <sub>stg</sub>	storage temperature		-65	+150	°C
P <sub>tot</sub>	total power dissipation	$T_{amb} = -40  ^{\circ}\text{C} \text{ to } +125  ^{\circ}\text{C}$	[1] -	500	mW

<sup>[1]</sup> For SO16 package: P<sub>tot</sub> derates linearly with 8 mW/K above 70 °C.
For TSSOP16 package: P<sub>tot</sub> derates linearly with 5.5 mW/K above 60 °C.
For DHVQFN16 package: P<sub>tot</sub> derates linearly with 4.5 mW/K above 60 °C.

## 9. Recommended operating conditions

Table 5. Recommended operating conditions

Symbol	Parameter	Conditions	74H	C4020-0	Q100	74H0	Unit		
			Min	Тур	Max	Min	Тур	Max	
$V_{CC}$	supply voltage		2.0	5.0	6.0	4.5	5.0	5.5	V
VI	input voltage		0	-	$V_{CC}$	0	-	$V_{CC}$	V
Vo	output voltage		0	-	$V_{CC}$	0	-	$V_{CC}$	V
Δt/ΔV	input transition rise and fall rate	except for Schmitt trigger inputs							
		V <sub>CC</sub> = 2.0 V	-	-	625	-	-	-	ns/V
		V <sub>CC</sub> = 4.5 V	-	1.67	139	-	1.67	139	ns/V
		V <sub>CC</sub> = 6.0 V	-	-	83	-	-	-	ns/V
T <sub>amb</sub>	ambient temperature		-40	+25	+125	-40	+25	+125	°C

## 10. Static characteristics

Table 6. Static characteristics

At recommended operating conditions; voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions		25 °C		-40 °C t	o +85 °C	-40 °C to	o +125 °C	Uni
			Min	Тур	Max	Min	Max	Min	Max	
74HC40	20-Q100					1		1	'	
$V_{IH}$	HIGH-level	V <sub>CC</sub> = 2.0 V	1.5	1.2	-	1.5	-	1.5	-	V
	input voltage	V <sub>CC</sub> = 4.5 V	3.15	2.4	-	3.15	-	3.15	-	V
		V <sub>CC</sub> = 6.0 V	4.2	3.2	-	4.2	-	4.2	-	V
V <sub>IL</sub>	LOW-level	$V_{CC} = 2.0 \text{ V}$	-	8.0	0.5	-	0.5	-	0.5	V
	input voltage	$V_{CC} = 4.5 \text{ V}$	-	2.1	1.35	-	1.35	-	1.35	V
		$V_{CC} = 6.0 \text{ V}$	-	2.8	1.8	-	1.8	-	1.8	V
V <sub>OH</sub>	HIGH-level	$V_I = V_{IH}$ or $V_{IL}$								
	output voltage	$I_O = -20 \mu A$ ; $V_{CC} = 2.0 \text{ V}$	1.9	2.0	-	1.9	-	1.9	-	V
		$I_O = -20 \mu A$ ; $V_{CC} = 4.5 \text{ V}$	4.4	4.5	-	4.4	-	4.4	-	V
		$I_O = -20 \mu A; V_{CC} = 6.0 V$	5.9	6.0	-	5.9	-	5.9	-	V
		$I_O = -4.0 \text{ mA}; V_{CC} = 4.5 \text{ V}$	3.98	4.32	-	3.84	-	3.7	-	V
		$I_{O} = -5.2 \text{ mA}; V_{CC} = 6.0 \text{ V}$	5.48	5.81	-	5.34	-	5.2	-	V
V <sub>OL</sub>	LOW-level	$V_I = V_{IH}$ or $V_{IL}$								
	output voltage	$I_O = 20 \mu A; V_{CC} = 2.0 V$	-	0	0.1	-	0.1	-	0.1	V
		$I_O = 20 \mu A$ ; $V_{CC} = 4.5 V$	-	0	0.1	-	0.1	-	0.1	V
		$I_O = 20 \mu A; V_{CC} = 6.0 V$	-	0	0.1	-	0.1	-	0.1	٧
		$I_O = 4.0 \text{ mA}$ ; $V_{CC} = 4.5 \text{ V}$	-	0.15	0.26	-	0.33	-	0.4	٧
		$I_O = 5.2 \text{ mA}; V_{CC} = 6.0 \text{ V}$	-	0.16	0.26	-	0.33	-	0.4	V
l <sub>l</sub>	input leakage current	$V_I = V_{CC}$ or GND; $V_{CC} = 6.0 \text{ V}$	-	-	±0.1	-	±1	-	±1	μА
I <sub>CC</sub>	supply current	$V_I = V_{CC}$ or GND; $I_O = 0$ A; $V_{CC} = 6.0 \text{ V}$	-	-	8.0	-	80	-	160	μА
Cı	input capacitance		-	3.5	-	-	-	-	-	pF
74HCT4	020-Q100									
V <sub>IH</sub>	HIGH-level input voltage	$V_{CC} = 4.5 \text{ V to } 5.5 \text{ V}$	2.0	1.6	-	2.0	-	2.0	-	V
V <sub>IL</sub>	LOW-level input voltage	$V_{CC} = 4.5 \text{ V to } 5.5 \text{ V}$	-	1.2	8.0	-	0.8	-	0.8	V
V <sub>OH</sub>	HIGH-level	$V_I = V_{IH}$ or $V_{IL}$ ; $V_{CC} = 4.5 \text{ V}$								
	output voltage	I <sub>O</sub> = -20 μA	4.4	4.5	-	4.4	-	4.4	-	V
		$I_{O} = -4.0 \text{ mA}$	3.98	4.32	-	3.84	-	3.7	-	٧
V <sub>OL</sub>	LOW-level	$V_I = V_{IH}$ or $V_{IL}$ ; $V_{CC} = 4.5 \text{ V}$								
-	output voltage	$I_O = 20 \mu A; V_{CC} = 4.5 \text{ V}$	-	0	0.1	-	0.1	-	0.1	V
		$I_O = 4.0 \text{ mA}; V_{CC} = 4.5 \text{ V}$	-	0.15	0.26	-	0.33	-	0.4	٧
I <sub>I</sub>	input leakage current	$V_{I} = V_{CC}$ or GND; $V_{CC} = 5.5 \text{ V}$	-	-	±0.1	-	±1	-	±1	μA

74HC\_HCT4020\_Q100

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 Table 6.
 Static characteristics ...continued

At recommended operating conditions; voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions		25 °C		–40 °C to	+85 °C	–40 °C to	+125 °C	Unit
			Min	Тур	Max	Min	Max	Min	Max	
I <sub>CC</sub>	supply current	$V_I = V_{CC}$ or GND; $I_O = 0$ A; $V_{CC} = 5.5 \text{ V}$	-	-	8.0	-	80	-	160	μΑ
ΔI <sub>CC</sub> additional supply current		$\begin{split} &V_{I}=V_{CC}-2.1 \text{ V; } I_{O}=0 \text{ A;} \\ &\text{other inputs at } V_{CC} \text{ or GND;} \\ &V_{CC}=4.5 \text{ V to } 5.5 \text{ V} \end{split}$								
		pin MR	-	110	396	-	495	-	539	μΑ
		pin CP	-	85	306	-	383	-	417	μΑ
Cı	input capacitance		-	3.5	-	-	-	-	-	pF

## 11. Dynamic characteristics

### Table 7. Dynamic characteristics

GND (ground = 0 V);  $C_L = 50$  pF unless otherwise specified; for test circuit, see Figure 10

Symbol	Parameter	Conditions		25 °C		-40 °C t	o +85 °C	–40 °C to	+125 °C	Unit
			Min	Тур	Max	Min	Max	Min	Max	
74HC402	20-Q100		'	'						
t <sub>pd</sub>	propagation	CP to Q0; see Figure 8	1							
	delay	$V_{CC} = 2.0 \text{ V}; C_L = 50 \text{ pF}$	-	39	140	-	175	-	210	ns
		$V_{CC} = 4.5 \text{ V}; C_L = 50 \text{ pF}$	-	14	28	-	35	-	42	ns
		$V_{CC} = 5.0 \text{ V}; C_L = 15 \text{ pF}$	-	11	-	-	-	-	-	ns
		$V_{CC} = 6.0 \text{ V}; C_L = 50 \text{ pF}$	-	11	24	-	30	-	36	ns
		Qn to Qn+1; see Figure 9								
		$V_{CC} = 2.0 \text{ V}; C_L = 50 \text{ pF}$	-	22	75	-	95	-	110	ns
		$V_{CC} = 4.5 \text{ V}; C_L = 50 \text{ pF}$	-	8	15	-	19	-	22	ns
		$V_{CC} = 5.0 \text{ V}; C_L = 15 \text{ pF}$	-	6	-	-	-	-	-	ns
		$V_{CC} = 6.0 \text{ V}; C_L = 50 \text{ pF}$	-	6	13	-	16	-	19	ns
t <sub>PHL</sub>	HIGH to LOW	MR to Qn; see Figure 8								
	propagation delay	$V_{CC} = 2.0 \text{ V}; C_L = 50 \text{ pF}$	-	55	170	-	215	-	225	ns
	delay	$V_{CC} = 4.5 \text{ V}; C_L = 50 \text{ pF}$	-	20	34	-	43	-	51	ns
		$V_{CC} = 5.0 \text{ V}; C_L = 15 \text{ pF}$	-	17	-	-	-	-	-	ns
		$V_{CC} = 6.0 \text{ V}; C_L = 50 \text{ pF}$	-	16	29	-	37	-	43	ns
t <sub>t</sub>	transition	Qn; see Figure 8	1							
	time	$V_{CC} = 2.0 \text{ V}; C_L = 50 \text{ pF}$	-	19	75	-	95	-	110	ns
		$V_{CC} = 4.5 \text{ V}; C_L = 50 \text{ pF}$	-	7	15	-	19	-	22	ns
		$V_{CC} = 6.0 \text{ V}; C_L = 50 \text{ pF}$	-	6	13	-	16	-	19	ns

 Table 7.
 Dynamic characteristics ...continued

GND (ground = 0 V);  $C_L = 50$  pF unless otherwise specified; for test circuit, see Figure 10

symbol	Parameter	Conditions			25 °C		-40 °C t	o +85 °C	-40 °C to	o +125 °C	Un
				Min	Тур	Max	Min	Max	Min	Max	
W	pulse width	CP HIGH or LOW;							ı		
		see Figure 8									
		$V_{CC} = 2.0 \text{ V}; C_L = 50 \text{ pF}$		80	14	-	100	-	120	-	ns
		$V_{CC} = 4.5 \text{ V}; C_L = 50 \text{ pF}$		16	4	-	20	-	24	-	ns
		$V_{CC} = 6.0 \text{ V}; C_L = 50 \text{ pF}$		14	3	-	17	-	20	-	ns
		MR HIGH; see Figure 8									
		$V_{CC} = 2.0 \text{ V}; C_L = 50 \text{ pF}$		80	17	-	100	-	120	-	ns
		$V_{CC} = 4.5 \text{ V}; C_L = 50 \text{ pF}$		16	6	-	20	-	24	-	ns
		$V_{CC} = 6.0 \text{ V}; C_L = 50 \text{ pF}$		14	5	-	17	-	20	-	ns
rec	recovery time	MR to CP; see Figure 8									
		$V_{CC} = 2.0 \text{ V}; C_L = 50 \text{ pF}$		50	6	-	65	-	75	-	ns
		$V_{CC} = 4.5 \text{ V}; C_L = 50 \text{ pF}$		10	2	-	13	-	15	-	ns
	$V_{CC} = 6.0 \text{ V}; C_L = 50 \text{ pF}$		9	2	-	11	-	13	-	ns	
f <sub>max</sub> maximum	see Figure 8										
	frequency	$V_{CC} = 2.0 \text{ V}; C_L = 50 \text{ pF}$		6.0	30	-	4.8	-	4.0	-	MF
		$V_{CC} = 4.5 \text{ V}; C_L = 50 \text{ pF}$		30	92	-	24	-	20	-	MH
	$V_{CC} = 5.0 \text{ V}; C_L = 15 \text{ pF}$		-	101	-	-	-	-	-	MF	
		$V_{CC} = 6.0 \text{ V}; C_L = 50 \text{ pF}$		35	109	-	28	-	24	-	MH
PD	power dissipation capacitance		[3]	-	19	-	-	-	-	-	pF
74HCT4	020-Q100										
pd	propagation	CP to Q0; see Figure 8	[1]								
	delay	$V_{CC} = 4.5 \text{ V}; C_L = 50 \text{ pF}$		-	18	36	-	45	-	54	ns
		$V_{CC} = 5.0 \text{ V}; C_L = 15 \text{ pF}$		-	15	-	-	-	-	-	ns
		Qn to Qn+1; see Figure 9									
		$V_{CC} = 4.5 \text{ V}; C_L = 50 \text{ pF}$		-	8	15	-	19	-	22	ns
		$V_{CC} = 5.0 \text{ V}; C_L = 15 \text{ pF}$		-	6	-	-	-	-	-	ns
PHL	HIGH to LOW	MR to Qn; see Figure 8									
	propagation	$V_{CC} = 4.5 \text{ V}; C_L = 50 \text{ pF}$		-	22	45	-	56	-	68	ns
	delay	$V_{CC} = 5.0 \text{ V}; C_L = 15 \text{ pF}$		-	19	-	-	-	-	-	ns
t	transition	Qn; see Figure 8	[2]								
-	time	$V_{CC} = 4.5 \text{ V}; C_L = 50 \text{ pF}$		-	7	15	-	19	-	22	ns
W	pulse width	CP HIGH or LOW; see Figure 8									
		$V_{CC} = 4.5 \text{ V}; C_L = 50 \text{ pF}$		20	7	-	25	-	30	-	ns
		MR HIGH; see Figure 8									
		$V_{CC} = 4.5 \text{ V}; C_L = 50 \text{ pF}$		20	8	-	25	-	30	-	ns
	recovery time	MR to CP; see Figure 8									
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Table 7. Dynamic characteristics ...continued

GND (ground = 0 V);  $C_L = 50$  pF unless otherwise specified; for test circuit, see Figure 10

Symbol	ymbol Parameter Conditions		25 °C			-40 °C to +85 °C		-40 °C to +125 °C		Unit
			Min	Тур	Max	Min	Max	Min	Max	
f <sub>max</sub> maximum frequency	see Figure 8									
	$V_{CC} = 4.5 \text{ V}; C_L = 50 \text{ pF}$	25	47	-	20	-	17	-	MHz	
		$V_{CC} = 5.0 \text{ V}; C_L = 15 \text{ pF}$	-	52	-	-	-	-	-	MHz
C <sub>PD</sub>	power dissipation capacitance	[5	] -	20	-	-	-	-	-	pF

- [1]  $t_{pd}$  is the same as  $t_{PHL}$  and  $t_{PLH}$ .
- [2]  $t_t$  is the same as  $t_{THL}$  and  $t_{TLH}$ .
- [3]  $C_{PD}$  is used to determine the dynamic power dissipation ( $P_D$  in  $\mu W$ ).

 $P_D = C_{PD} \times V_{CC}^2 \times f_i + \Sigma (C_L \times V_{CC}^2 \times f_o)$  where:

f<sub>i</sub> = input frequency in MHz;

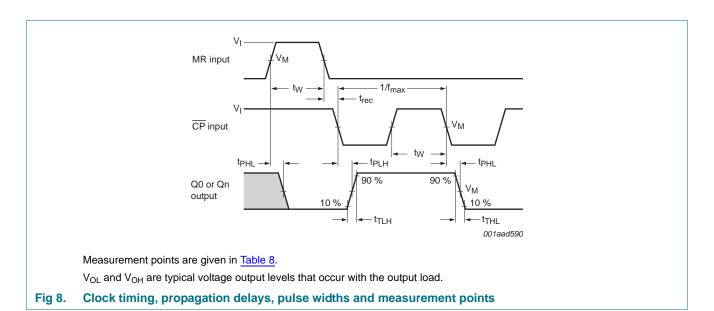
f<sub>o</sub> = output frequency in MHz;

 $\Sigma$  (C<sub>L</sub>  $\times$  V<sub>CC</sub><sup>2</sup>  $\times$  f<sub>o</sub>) = sum of outputs;

C<sub>L</sub> = output load capacitance in pF;

V<sub>CC</sub> = supply voltage in V.

### 12. Waveforms



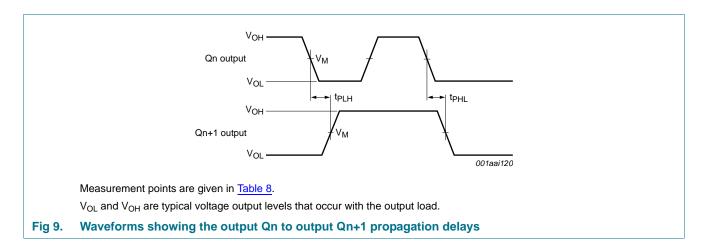
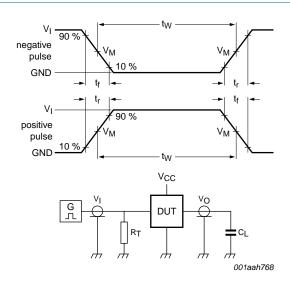


Table 8. Measurement points

Туре	Input	Output
	V <sub>M</sub>	V <sub>M</sub>
74HC4020-Q100	$0.5 \times V_{CC}$	$0.5 \times V_{CC}$
74HCT4020-Q100	1.3 V	1.3 V



Test data is given in Table 9.

Definitions test circuit:

 $R_T$  = Termination resistance should be equal to output impedance  $Z_o$  of the pulse generator.

 $C_L$  = Load capacitance including jig and probe capacitance.

Fig 10. Test circuit for measuring switching times

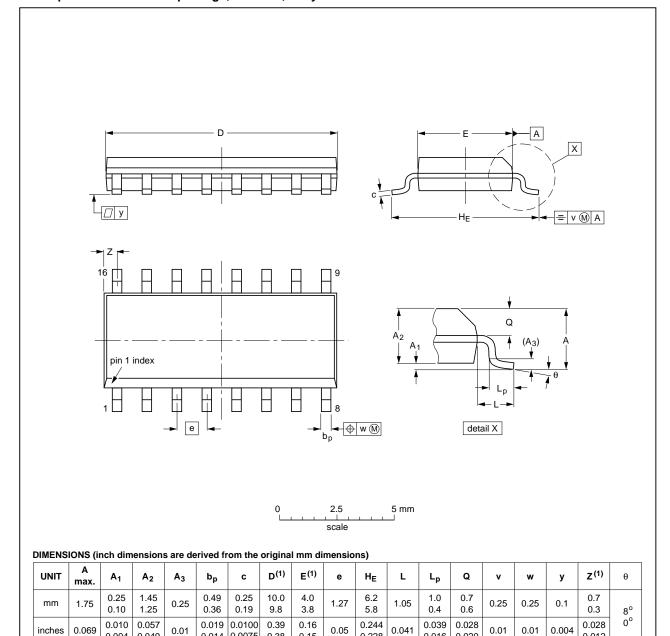
Table 9. Test data

Туре	Input		Load
	VI	t <sub>r</sub> , t <sub>f</sub>	C <sub>L</sub>
74HC4020-Q100	V <sub>CC</sub>	6 ns	15 pF, 50 pF
74HCT4020-Q100	3 V	6 ns	15 pF, 50 pF

## 13. Package outline

SO16: plastic small outline package; 16 leads; body width 3.9 mm

SOT109-1



1. Plastic or metal protrusions of 0.15 mm (0.006 inch) maximum per side are not included.

0.014 0.0075

0.38

0.15

OUTLINE		REFER	EUROPEAN	ISSUE DATE			
VERSION	IEC	JEDEC	JEITA		PROJECTION	1000E DATE	
SOT109-1	076E07	MS-012				<del>99-12-27</del> 03-02-19	

0.228

0.016

Fig 11. Package outline SOT109-1 (SO16)

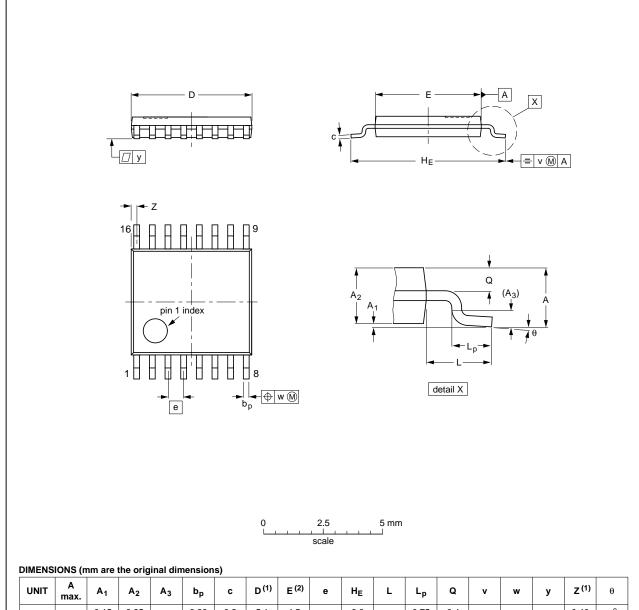
0.004

0.049

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TSSOP16: plastic thin shrink small outline package; 16 leads; body width 4.4 mm

SOT403-1



-							-,												
	UNIT	A max.	A <sub>1</sub>	A <sub>2</sub>	A <sub>3</sub>	bp	С	D <sup>(1)</sup>	E (2)	е	HE	L	Lp	Q	v	w	у	Z <sup>(1)</sup>	θ
	mm	1.1	0.15 0.05	0.95 0.80	0.25	0.30 0.19	0.2 0.1	5.1 4.9	4.5 4.3	0.65	6.6 6.2	1	0.75 0.50	0.4 0.3	0.2	0.13	0.1	0.40 0.06	8° 0°

- 1. Plastic or metal protrusions of 0.15 mm maximum per side are not included.
- 2. Plastic interlead protrusions of 0.25 mm maximum per side are not included.

		EUROPEAN	ISSUE DATE	
JEDEC	JEITA	PROJECTION	ISSUE DATE	
MO-153			<del>99-12-27</del> 03-02-18	

Fig 12. Package outline SOT403-1 (TSSOP16)

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DHVQFN16: plastic dual in-line compatible thermal enhanced very thin quad flat package; no leads; 16 terminals; body 2.5 x 3.5 x 0.85 mm SOT763-1

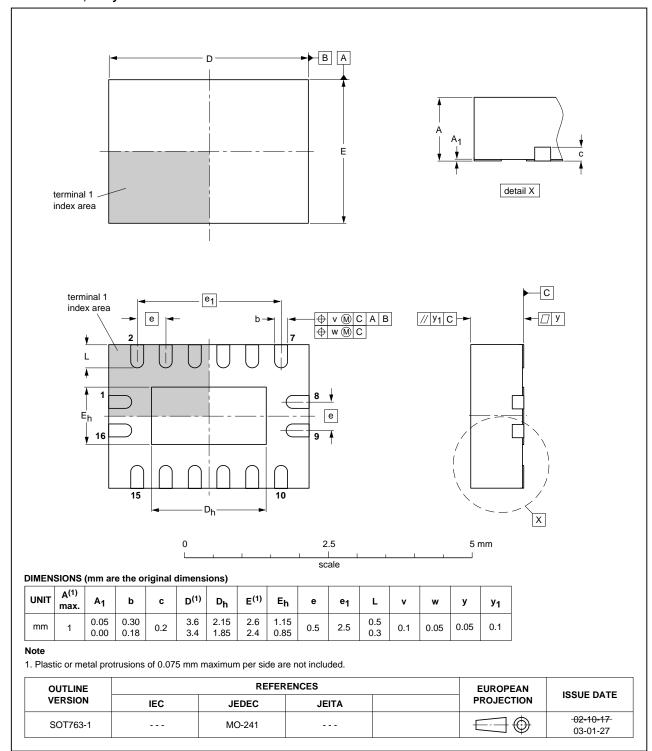


Fig 13. Package outline SOT763-1 (DHVQFN16)

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## 14. Abbreviations

### Table 10. Abbreviations

Acronym	Description
CMOS	Complementary Metal-Oxide Semiconductor
DUT	Device Under Test
ESD	ElectroStatic Discharge
НВМ	Human Body Model
MIL	Military
MM	Machine Model
TTL	Transistor-Transistor Logic

# 15. Revision history

### Table 11. Revision history

Document ID	Release date	Data sheet status	Change notice	Supersedes
74HC_HCT4020_Q100 v.1	20130523	Product data sheet	-	-

## 16. Legal information

### 16.1 Data sheet status

Document status[1][2]	Product status[3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

- [1] Please consult the most recently issued document before initiating or completing a design.
- [2] The term 'short data sheet' is explained in section "Definitions"
- [3] The product status of device(s) described in this document may have changed since this document was published and may differ in case of multiple devices. The latest product status information is available on the Internet at URL http://www.nxp.com.

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### 14-stage binary ripple counter

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14-stage binary ripple counter

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